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**2023-2024**

**TEHCET's CMR™**

**CERAMIC**

FABRICATED PARTS, MATERIAL SEGMENT  
FOR SEMI-CONDUCTOR APPLICATIONS

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## RESEARCH METHODOLOGY

TEHCET employs subject matter experts having first-hand experience within the industries which they analyze. Most of TEHCET's analysts have over 25 years of direct and relevant experience in their field. Our analysts survey the commercial and technical staff of IC manufacturers and their suppliers and conduct extensive research of literature and commerce statistics to ascertain the current and future market environment and global supply risks. Combining this data with TEHCET's proprietary, quantitative wafer forecast results in a viable long-term market forecast for a variety of process materials.

This report represents the interpretation and analysis of information generally available to the public or released by responsible agencies or individuals. Data was obtained from sources considered reliable. However, accuracy or completeness is not guaranteed.

## ANALYST BIOGRAPHY



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## 2 SCOPE, PURPOSE AND METHODOLOGY

### 2.1 SCOPE

This report is focused on technical ceramic materials market and supply-chain which includes  $\text{Al}_2\text{O}_3$ , SiC/ CVD SiC, AlN,  $\text{Y}_2\text{O}_3$ , and BN used in the production of components and assemblies for use in semiconductor process equipment. We gathered information from primary research (field interviews), commonly available industry information, patent and IP (intellectual property) based knowledge, and combined this with available data base information to form the basis of this report.

SiC is frequently used for both carriers (boats, gas injectors, and fabware) and components for OEMs where high temperature or specific thermal packages are required, while traditional  $\text{Al}_2\text{O}_3$  and AlN ceramics are normally used for lower temperature / etch applications.

The machines/tools manufacturers that use these components are referred to as OEMs (Original Equipment Manufacturers). This report targets ceramics used in the manufacture of semiconductors, only. The report contains data and analysis from TECHCET's data base and Sr. Analyst experience, as well as that developed from primary and secondary market research. For more information on TECHCET Critical materials Reports™ please go to <https://TECHCET.com>

### 2.2 PURPOSE

This Critical Materials Report™ (CMR) provides focused information for supply-chain managers, process integration and R&D directors, as well as business development managers, and financial analysts. The report covers information about key suppliers, issues/trends in the material supply chain, estimates on supplier market share, and forecast for the material segments.

This report aims to provide an overview to the above scope ceramic material and parts supply chain, serving the semiconductor industry. This information about this critical material is essential in the running of the semiconductor wafer fabs across the world. The goal is to annually track the state of the industry; the health of the supply and demand; to pinpoint any shortcomings or issues faced by the industry; and to provide a guidance for purchasing and industry quality improvement decisions. We hope to provide a dialog and feedback opportunities for related stakeholders to fine-tune and better manage the supply ups and downs.

### 2.3 METHODOLOGY

TEHCET employs subject matter experts having first-hand experience within the industries which they analyze. Most of TECHCET's analysts have over 25 years of direct and relevant experience in their field. Our analysts survey the commercial and technical staff of IC manufacturers and their suppliers and conduct extensive research of literature and commerce statistics to ascertain the current and future market environment and global supply risks. Combining this data with TECHCET's proprietary, quantitative wafer forecast results in a viable long-term market forecast for a variety of process materials.



We track micro-economic and macro-economic trends pertaining to the semiconductor industry and track overall industry trend and needs, equipment supply and demand situation, deduction towards the quartz material requirement, and supplier/fabricators situation one by one. From this vantage point, we check the suppliers/fabricators and the base material company information, and then the raw materials market information. Included in our work is an analysis of public information, website information, supplier interviews, supplier surveys, supplier peer-data cross-checking, and reference comparison. In addition, we conduct a material base usage calculation with respect to a demand and supply micro-economic analysis. We then conduct a forward and backward sweep of the forecast until data is in sync. In the meantime, for the data points that are missing, we use past historic, forward-looking data, and peer data so to extrapolate from three different levels of cross-checking. This provides us an estimation based on judgment from industry experience. In this year's report, we especially added special industry situation reporting and analysis for exogenous factors affecting the industry, which can be big percentage influence factors than normal trend parameter contributors.

## 2.4 OVERVIEW OF OTHER TECHCET CMR™ REPORTS

TEHCET produces electronic material supply chain reports each year as one of its functions for the Critical Materials Council. Reports to be published in 2019 can be found at [www.techcet.com](http://www.techcet.com) and are listed in the table below:

**Table 2: TECHCET Critical Material Reports**

TEHCET's Critical Materials Reports™	
1	CMP Consumables (Pads & Slurry)
2	CMP Equipment Ancillaries (Conditioners, Filters, etc.)
3	CVD /ALD Hi K Precursors
4	CVD DIELECTRIC Precursors
5	Equipment Components – Quartz
6	Equipment Components – Silicon
7	Equipment Components – SiC/Ceramics
8	Gases - Electronic Specialty, Bulk & Rare Gases
9	Metal Plating Chemicals
10	Photoresists, Ancillaries & Extension Materials
11	Sputtering Targets
12	Wafers: Silicon, SOI
13	SiC Wafers & Manufacturing
14	Wet Chemicals / Specialty Cleans
15	Special Reports: Impact of US Expansions on Wet Chemicals Supply Chains